

1c997 U.S. PTO
10/057448

01/25/02

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U.S. UTILITY Patent Application

PATENT NUMBER and
ISSUE DATE

11/05/03

APPL NUM	FILING DATE	CLASS	SUBCLASS	GAU	EXAMINER
10057448	01/25/2002	257	693	2815	Warren

****APPLICANTS:** Wang Daniel;

****CONTINUING DATA VERIFIED:**
THIS APPLICATION IS A CON OF 08/761,365 12/09/1996 ABN

**** FOREIGN APPLICATIONS VERIFIED:**

PG-PUB	DO NOT PUBLISH <input type="checkbox"/>	RESCIND <input type="checkbox"/>
Foreign priority claimed <input type="checkbox"/> yes <input type="checkbox"/> no		ATTORNEY DOCKET NO
35 USC 119 conditions met <input type="checkbox"/> yes <input type="checkbox"/> no		669-77 CON
Verified and Acknowledged Examiners's initials		
TITLE : High density integrated circuits and the method of packaging the same		

U.S. DEPT. OF COMM./PAT & TM-PTO-435L (Rev. 12-94)

NOTICE OF ALLOWANCE MAILED		CLAIMS ALLOWED	
		Total Claims	Print Claim for O.G.
Assistant Examiner		DRAWING	
Amount Due		Sheets Drwg.	Figs.Drwg.
Date Paid		Print Fig.	
Primary Examiner		Application Examiner	
<input type="checkbox"/> TERMINAL DISCLAIMER		PREPARED FOR ISSUE	
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